4V Drive Nch+SBD MOSFET **US5U2**

●Structure

Silicon N-channel MOSFET / Schottky barrier diode

● Features

- 1) Nch MOSFET and schottky barrier diode are put in TUMT5 package.
- 2) High-speed switching, Low On-resistance.
- 3) 4V drive.
- 4) Built-in Low VF schottky barrier diode.

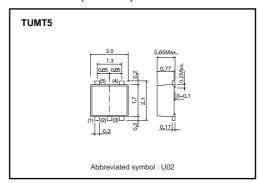
Applications

Switching

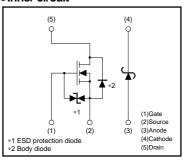
Packaging specifications

	Package	Taping		
Type	Code TR			
	Basic ordering unit (pieces)	3000		
US5U2		0		

●Dimensions (Unit:mm)



•Inner circuit



● Absolute maximum ratings (Ta=25°C)

<MOSFET>

Parameter	Symbol	Limits	Unit	
Drain-source voltage		V_{DSS}	30	V
Gate-source voltage		Vgss	20	V
Drain current	Continuous	I_D	±1.4	Α
Drain current	Pulsed	I _{DP} *1	±5.6	Α
Source current	Continuous	Is	0.6	A
(Body diode)	Pulsed	Isp *1	5.6	Α
Power dissipation		P _D *2	0.7	W / ELEMENT
Channel temperature		Tch	150	°C

^{*1} Pw≤10μs, Duty cycle≤1% *2 Mounted on a ceramic board

<Di>

Parameter	Symbol	Limits	Unit
Repetitive peak reverse voltage	V _{RM}	30	V
Reverse voltage	VR	20	V
Forward current	l _F	0.5	Α
Forward current surge peak	I _{FSM} *1	2.0	Α
Power dissipation	P _D *2	0.5	W / ELEMENT
Junction temperature	Tj	150	°C

<MOSFET and Di>

Parameter	Symbol	Limits	Unit
Total power dissipation	P _D *1	1.0	W / TOTAL
Range of storage temperature	Tstg	-55 to +150	°C

^{*1} Mounted on a ceramic board

●Electrical characteristics (Ta=25°C)

<MOSFET>

Symbol	Min.	Тур.	Max.	Unit	Conditions
Igss	-	_	10	μΑ	V _{GS} =20V, V _{DS} =0V
V _{(BR) DSS}	30	_	_	V	I _D = 1mA, V _{GS} =0V
IDSS	-	_	1	μΑ	V _{DS} = 30V, V _{GS} =0V
VGS (th)	1.0	_	2.5	V	V _{DS} = 10V, I _D = 1mA
	_	170	240	mΩ	I _D = 1.4A, V _{GS} = 10V
R _{DS (on)} *	_	250	350	mΩ	I _D = 1.4A, V _{GS} = 4.5V
	-	270	380	mΩ	I _D = 1.4A, V _G S= 4V
Y _{fs} *	1.0	_	_	S	V _{DS} = 10V, I _D = 1.4A
Ciss	_	70	_	pF	V _{DS} = 10V
Coss	_	15	_	pF	V _{GS} =0V
Crss	_	12	_	pF	f=1MHz
t _{d (on)} *	_	6	_	ns	Vpp≒ 15V
tr *	_	6	_	ns	I _D = 0.7A V _G s= 10V
t _{d (off)} *	_	13	_	ns	$R_{L}=21\Omega$
t _f *	_	8	_	ns	R _G =10Ω
Q _g *	_	1.4	2.0	nC	V _{DD} ≒15V, V _{GS} =5V
Qgs *	_	0.6	_	nC	ID= 1.4A
Q _{gd} *	_	0.3	_	nC	$R_L=11\Omega$, $R_G=10\Omega$
	IGSS	IGSS	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$

^{*}Pulsed

<Body diode characteristics (source-drain)>

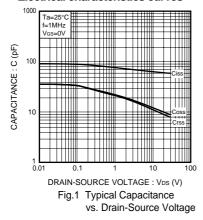
Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward voltage	Vsp	_	_	1.2	V	I _S = 0.6A, V _{GS} =0V

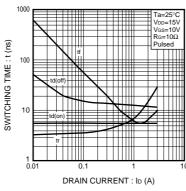
<Di>

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward voltage	VF	_	_	0.36	V	I _F = 0.1A
		-	_	0.47	V	I _F 0.5A
Reverse current	l _R	-	-	100	μΑ	V _R = 20V

^{*1 60}Hz • 1 cycle *2 Mounted on ceramic board

•Electrical characteristics curves





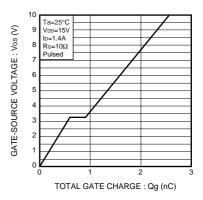


Fig.2 Switching Characteristics

Fig.3 Dynamic Input Characteristics

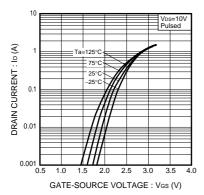


Fig.4 Typical Transfer Characteristics

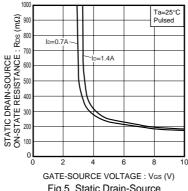


Fig.5 Static Drain-Source
On-State Resistance vs.
Gate-source Voltage

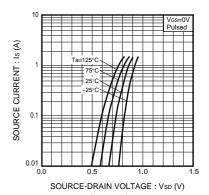


Fig.6 Source Current vs. Source-Drain Voltage

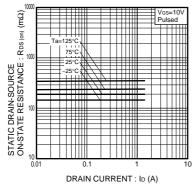


Fig.7 Static Drain-Source On-State Resistance vs. Drain Current (I)

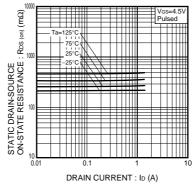


Fig.8 Static Drain-Source On-State Resistance vs. Drain Current (II)

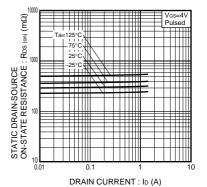


Fig.9 Static Drain-Source On-State Resistance vs. Drain Current (III)

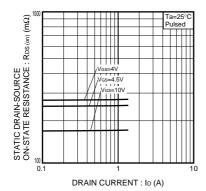


Fig.10 Static Drain-Source On-State Resistance vs. Drain Current (IV)

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